Docket No.: RGP-0175

ORM PTO-1595 (Modified) RECORDATION FORM COVER SHEET U.S. DEPARTMENT OF COMMERC Rev. 03-01)		
OMB No. 0651-0027 (exp.5/31/2002) POBA/REV03 PATENTS ONLY Patent and Trademark Office		
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To the Director of the United States Patent and Trademark Office: Please record the attached original documents or copy thereof.		
Name of conveying party(ies): Murali Sethumadhavan Scott D. Kennedy	Name and address of receiving party(ies): Name: World Properties, Inc. Address: 7366 North Lincoln Avenue, Suite 410	
Carlos L. Barton		
Additional names(s) of conveying party(ies)		
3. Nature of conveyance:		
☑ Assignment ☐ Merger		
☐ Security Agreement ☐ Change of Name	City: Lincolnwood S	State/Prov.: <u>IL</u>
☐ Other	Country: USA	ZIP: <u>60712</u>
Execution Date: 08/27/04; 08/30/04; 08/25/04	Additional name(s) & address(es)	□ Yes ⊠ No
4. Application number(s) or patent numbers(s): If this document is being filed together with a new application, the execution date of the application is: Patent Application No. Filing date B. Patent No.(s)		
	, ,	
10/873,405 June 21, 2004 Additional numbers	□ Yes 🗷 No	
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:	
Name; Leah M. Reimer	7. Total fee (37 CFR 3.41):.	\$ 40,00
Registration No. 39,341	☐ Enclosed - Any excess or insufficiency should be credited or debited to deposit account	
Address: Cantor Colburn LLP		
55 Griffin Road South	Authorized to be charged to deposit account	
,	8. Deposit account number:	
City: Bloomfield State/Prov.: CT	06-1130	
Country: USA ZIP: 06002	(Attach duplicate copy of this	page if paying by deposit account)
DO NOT USE THIS SPACE		
Statement and signature. To the best of my knowledge and bellef, the foregoing information of the original document. Leah M. Reimer	ation is true and correct and a	ny attached copy is a true copy September 3, 2004
Name of Person Signing	Signature	3 Date
Total number of pages including o	over sheet, attachments, and required cover sheet information to:	PATENT

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ASSIGNMENT

WHEREAS We, Murali Sethumadhavan of 29 Hemingway Street, Shrewsbury, MA 01545, in the County of Worcester, Scott D. Kennedy of 441 S. Canterbury Road, Canterbury, CT 06331, in the County of Windham and Carlos L. Barton of 472 Allen Hill Road, Brooklyn, CT 06234 in the County of Windham; (hereinafter "ASSIGNORS") have invented certain new and useful improvements in:

CIRCUITS, MULTI-LAYER CIRCUITS, AND METHODS OF MANUFACTURE THEREOF

for which we have filed application for Letters Patent of the United States on June 21, 2004, U.S. Patent Application No. 10/873,405;

AND WHEREAS, WORLD PROPERTIES, INC., a corporation organized and existing under the laws of the State of Illinois, having a place of business at 7366 North Lincoln Avenue, Suite 410, Lincolnwood, IL 60712, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefore;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and sufficient consideration the, receipt of which is hereby acknowledged, We, the said ASSIGNORS; have sold, assigned, and transferred, and by these presents do sell, assign and transfer unto the said WORLD PROPERTIES, INC., the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said WORLD PROPERTIES. INC., an assignce of the entire right, title and interest in and to the same, for the sole use and behoof of WORLD PROPERTIES, INC., its successors and assigns; and We do hereby agree that the said WORLD PROPERTIES, INC., may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said WORLD PROPERTIES. INC., its successors or assigns, and that We will, at the cost and expense of the said WORLD PROPERTIES, INC., fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

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The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 27-my-04

Date: 8/30/04

Date: 25 Aug 04

J. Huraly.

Murali Sethumadhavan

PATENT REEL: 015104 FRAME: 0965

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